



Si Detectors Test of Day-one Experiment Setup

Q.Hu, J. Ritman, H. Xu

PANDA collaboration meeting @ Paris Sept. 11, 2012

Mitglied der Helmholtz-Gemeinschaft





Introduction of day-one experiment setup





Structure of the Si detectors





Ceramic Dimensions:95.00*64.00 mm²Chip Dimensions:80.32*53.50 mm²Active Area:76.82*50.00 mm²

Si_1 (Si_2591-13) Thickness: 1043 μm Depletion: 65 V

Si_2 (Si_2591-15) Thickness: 1045 μm Depletion: 52 V

Operating voltage: 200 V (max) Dead layer: < 0.1 μm





Test setup & conditions







V – I curve @ 299 K







Energy spectra of the front side (Si_1 & Si_2) @ 180 V







Energy resolution (FWHM) vs. Voltage (Si_1 & Si_2)







Energy spectra of the rear side (Si_1 & Si_2) @ 180 V







Calibration study

Pulse Generator: ORTEC Model 419







Summary

- 1. The electronics runs well;
- 2. Si detectors meet our requirement.

Next step

- 1. Further test for Ge detectors;
- 2. Energy calibration;
- 3. Development of temperature controller.







$$E'_{\alpha 1} = E_{\alpha 1} - E_{1_loss}$$

$$E'_{\alpha 2} = E_{\alpha 2} - E_{2_loss}$$

$$FWHM = 2.355^* \sigma^* (E'_{\alpha 1} - E'_{\alpha 2}) / (Mean_1 - Mean_2)$$